Unit: mm

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π–MOSV)

## 2SK2508

# Switching Regulator and DC-DC Converter and Motor Applications

• Low drain-source ON resistance : RDS (ON) =  $0.18 \Omega$  (typ.)

• High forward transfer admittance :  $|Y_{fs}| = 13 \text{ S (typ.)}$ • Low leakage current :  $I_{DSS} = 100 \mu A \text{ (max) (V}_{DS} = 250 \text{ V)}$ 

• Enhancement mode :  $V_{th} = 1.5 \sim 3.5 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA})$ 

### **Absolute Maximum Ratings (Ta = 25°C)**

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		$V_{DSS}$	250	V	
Drain-gate voltage (R <sub>GS</sub> = 20 kΩ)		$V_{DGR}$	250	V	
Gate-source voltage		V <sub>GSS</sub>	±20	V	
Drain current	DC (Note 1)	I <sub>D</sub>	13	Α	
	Pulse (Note 1)	I <sub>DP</sub>	52	Α	
Drain power dissipation	n (Tc = 25°C)	PD	45	W	
Single pulse avalanche energy (Note 2)		E <sub>AS</sub>	148	mJ	
Avalanche current		I <sub>AR</sub>	13	Α	
Repetitive avalanche energy (Note 3)		E <sub>AR</sub>	4.5	mJ	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55~150	°C	

1. GATE
2. DRAIN
3. SOURCE

JEDEC

JEITA

SC-67

TOSHIBA

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Weight: 1.9 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R <sub>th (ch-c)</sub>	2.78	°C/W
Thermal resistance, channel to ambient	R <sub>th (ch-a)</sub>	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2:  $V_{DD}$  = 50 V,  $T_{ch}$  = 25°C (initial), L = 1.48 mH,  $R_{G}$  = 25  $\Omega$ ,  $I_{AR}$  = 13 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device.

Please handle with caution.



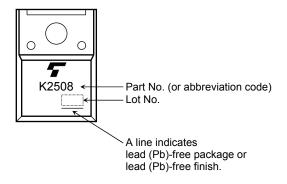
## **Electrical Characteristics (Ta = 25°C)**

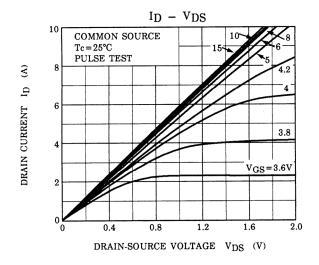
Charac	eteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	rrent	I <sub>GSS</sub>	V <sub>GS</sub> = ±16 V, V <sub>DS</sub> = 0 V	_	_	±10	μΑ
Drain cut-off cu	rrent	I <sub>DSS</sub>	V <sub>DS</sub> = 250 V, V <sub>GS</sub> = 0 V		_	100	μA
Drain-source br	eakdown voltage	V (BR) DSS	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	250	_	_	V
Gate threshold v	voltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	1.5	_	3.5	V
Drain-source O	N resistance	R <sub>DS</sub> (ON)	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 6.5 A	_	0.18	0.25	Ω
Forward transfer	admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 6.5 A	6	13	_	S
Input capacitano	:e	C <sub>iss</sub>		_	1800	_	
Reverse transfe	r capacitance	C <sub>rss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	130	_	pF
Output capacitance		Coss	]		500	_	
Switching time	Rise time	t <sub>r</sub>	$V_{GS}$ $\stackrel{10V}{\underset{OV}{\bigcap}}$ $\stackrel{I_{D}=6.5A}{\underset{R_{L}=20\Omega}{\bigvee}}$ $V_{DD}$ $\stackrel{=}{\underset{130V}{\rightleftharpoons}}$ $130V$	_	15	_	
	Turn-on time	t <sub>on</sub>		_	25	_	no
	Fall time	t <sub>f</sub>		_	10	_	ns
	Turn-off time	t <sub>off</sub>	Duty $\leq 1\%$ , $t_{\rm W} = 10 \mu \rm s$	_	70	_	
Total gate charge (Gate-source plus gate-drain)		Qg		_	40	_	
Gate-source charge		Q <sub>gs</sub>	$V_{DD} \approx 200 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 13 \text{ A}$		25	_	nC
Gate-drain ("miller") charge		$Q_{gd}$			15	_	

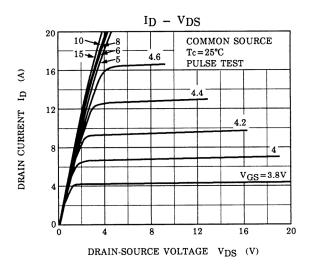
### **Source-Drain Ratings and Characteristics (Ta = 25°C)**

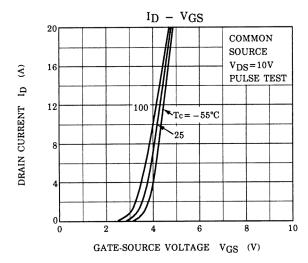
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>	_	_	_	13	Α
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	_	_	_	52	А
Forward voltage (diode)	V <sub>DSF</sub>	I <sub>DR</sub> = 13 A, V <sub>GS</sub> = 0 V	_	_	-2.0	V
Reverse recovery time	t <sub>rr</sub>	I <sub>DR</sub> = 13 A, V <sub>GS</sub> = 0 V		260	_	ns
Reverse recovery charge	Q <sub>rr</sub>	dl <sub>DR</sub> / dt = 100 Å / μs	_	0.3	_	μC

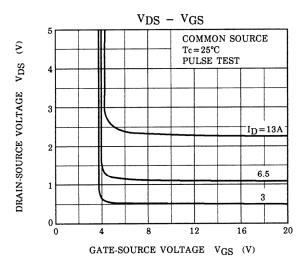
## Marking

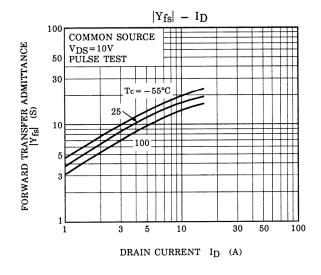


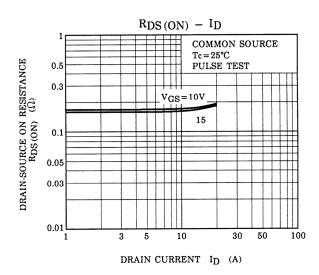


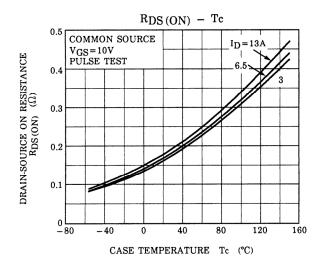


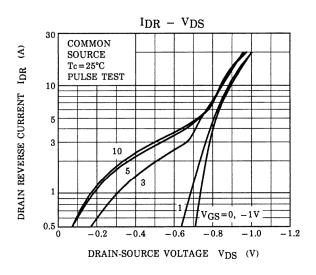


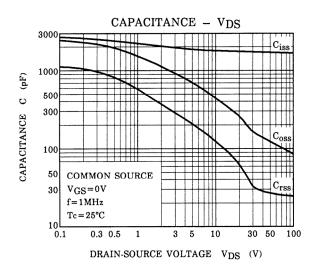


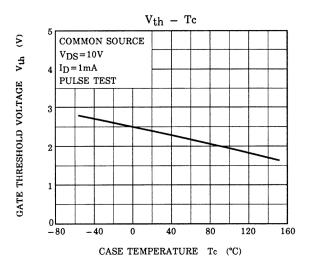


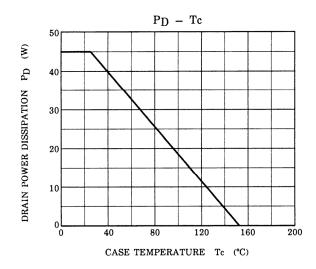


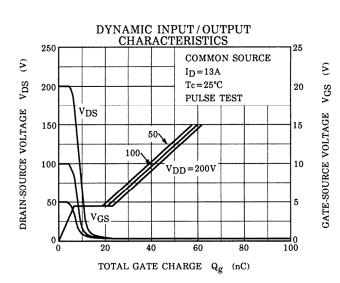


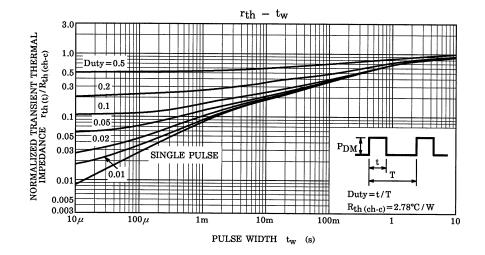


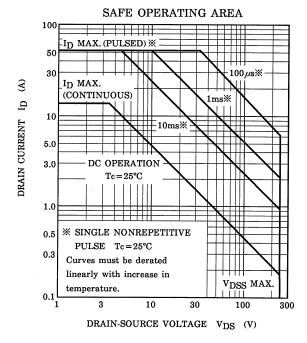


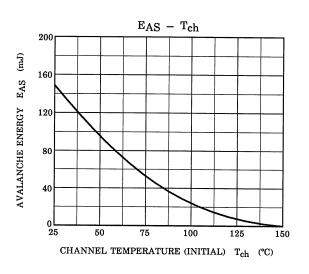


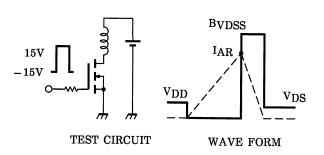












$$\begin{split} &R_{G}=25~\Omega\\ &V_{DD}=50~V,~L=1.48~mH \end{split} \tag{EAS}$$

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$$EAS = \frac{1}{2} \cdot L \cdot I^{2} \cdot \left( \frac{BVDSS}{BVDSS - VDD} \right)$$

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